INTEGRATED CIRCUITS

DATA SHEET

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

74AHC1G86; 74AHCT1G86 2-input EXCLUSIVE-OR gate

Product specification Supersedes data of 2002 Feb 18

2002 Jun 06





2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86

FEATURES

- Symmetrical output impedance
- · High noise immunity
- · ESD protection:
 - HBM EIA/JESD22-A114-A exceeds 2000 V
 - MM EIA/JESD22-A115-A exceeds 200 V
 - CDM EIA/JESD22-C101 exceeds 1000 V.
- Low power dissipation
- Balanced propagation delays
- · Very small 5-pin package
- · Output capability: standard
- Specified from –40 to +125 °C.

DESCRIPTION

The 74AHC1G/AHCT1G86 is a high-speed Si-gate CMOS

The 74AHC1G/AHCT1G86 provides the 2-input EXCLUSIVE-OR function.

QUICK REFERENCE DATA

Ground = 0 V; T_{amb} = 25 °C; t_r = $t_f \le 3.0$ ns.

CVMDOL	Y.COMP.	CONDITIONS	TYP	TYPICAL			
SYMBOL	PARAMETER	CONDITIONS	AHC1G	AHCT1G	UNIT		
t _{PHL} /t _{PLH}	propagation delay A and B to Y	$C_L = 15 \text{ pF}; V_{CC} = 5 \text{ V}$	3.4	3.5	ns		
CI	input capacitance	N. T. CONT.	1.5	1.5	pF		
C _{PD}	power dissipation capacitance	C _L = 50 pF; f = 1 MHz; notes 1 and 2	9	11 12.CG	pF		

Notes

$$P_D = C_{PD} \times V_{CC}^2 \times f_i + (C_L \times V_{CC}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts.

2. The condition is $V_I = GND$ to V_{CC} .

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FUNCTION TABLE

M:T		INPL	UTS	WWW.I	ОИТРИТ
ON.TW	A	M. 1007	CONT. B	MAN	V.COM Y
OWIT	L	W.100	CONT.	WWW.1	OV.COM TWL
COMITY	L	N 100	COM: H	WW.I	COM
WI.MO	Н	W 11	DAY THE	W.	TON'T H
I.CO. TAN	Н	MM	HYENE	MAN	1001. OM.TE

Note

1. H = HIGH voltage level; L = LOW voltage level.

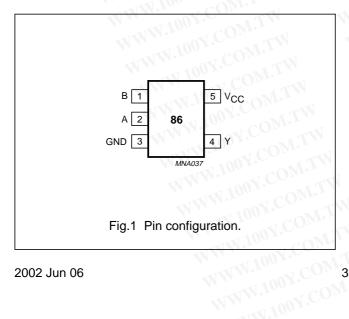
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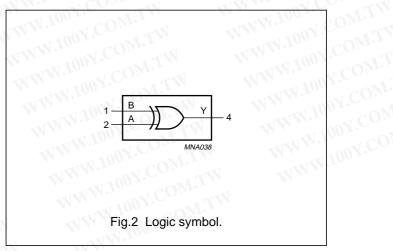
ORDERING INFORMATION

	I.WW.1		PACKAGE	S		
TYPE NUMBER	TEMPERATURE RANGE	PINS	PACKAGE	MATERIAL	CODE	MARKING
74AHC1G86GW	-40 to +125 °C	5 1.0	SC-88A	plastic	SOT353	AH
74AHCT1G86GW	-40 to +125 °C	5	SC-88A	plastic	SOT353	CH
74AHC1G86GV	-40 to +125 °C	5	SC-74A	plastic	SOT753	A86
74AHCT1G86GV	-40 to +125 °C	5	SC-74A	plastic	SOT753	C86

PINNING

WW 100X	.Com.TW	MAN TOO S. COMPAN AND TOO S. COMPAN
PINNING		
PIN	SYMBOL	DESCRIPTION
1/1	В	data input B
2	A	data input A
3	GND	ground (0 V)
4	Y COM	data output Y
5	V _{cc}	supply voltage

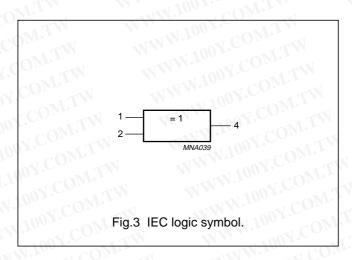


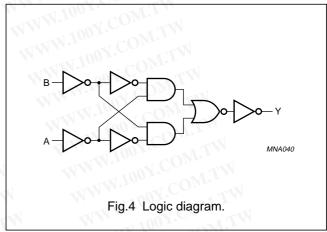


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2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86





RECOMMENDED OPERATING CONDITIONS

CVMDOL	DADAMETED	CONDITIONS	11.1	74AHC1	G	W.107	4AHCT	1G	
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	UNIT
V _{CC}	supply voltage	W. 1003.	2.0	5.0	5.5	4.5	5.0	5.5	٧
VI	input voltage	WW. 1007.	0	17	5.5	0	TOO I.	5.5	V
Vo	output voltage	WW. 100X	0	TW	V _{CC}	0	+00%	V _C C	V
T _{amb}	operating ambient temperature	see DC and AC characteristics per device	-40	+25	+125	-40	+25	+125	°C
t_r , t_f ($\Delta t/\Delta f$)	input rise and fall	$V_{CC} = 3.3 \pm 0.3 \text{ V}$	10-17.CC	- T.T.	100	- 1/1	- 31 10		ns/V
	times	$V_{CC} = 5 \pm 0.5 \text{ V}$	J.Y.C	D2.	20	- 1	Ø.	20	ns/V

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CC}	supply voltage	WWW. 100Y. COM.TH	-0.5	+7.0	V
VI	input voltage	WWW. 100Y. COLITY	-0.5	+7.0	V
I _{IK}	input diode current	V _I < -0.5 V	- 1	-20	mA
lok	output diode current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}; \text{ note 1}$		±20	mA
Io	output source or sink current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	Ī-	±25	mA
Icc	V _{CC} or GND current	IN TAN TOOL CONT. I.A.	_	±75	mA
T _{stg}	storage temperature	TW WW TILOUT. OMIT	-65	+150	°C 10
P _D	power dissipation per package	for temperature range from -40 to +125 °C	1/2	250	mW

Note

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86

DC CHARACTERISTICS

Family 74AHC1G

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

	WWW	TEST CONDITI	ONS			100	T _{amb} (°(C) (1			
SYMBOL	PARAMETER	W.IO.	V _{CC}		25	N.10	-40 t	to +85	-40 to	+125	UNI
		OTHER	(V)	MIN.	TYP.	MAX.	MIN.	MAX.	MIN.	MAX.	
V _{IH}	HIGH-level input	MM:100 CO	2.0	1.5	- 1	This	1.5	ON	1.5	_	V
	voltage	WW.100 x CC	3.0	2.1	- 4	711	2.1	GOM	2.1	_	V
001	M.TW	W.1007.	5.5	3.85	-		3.85	701	3.85	_	V
V _{IL}	LOW-level input	MM. 100X.	2.0	EN.	_	0.5	1700	0.5	4	0.5	V
	voltage	WW 100Y	3.0	411	_	0.9	- 10	0.9	\overline{T}	0.9	V
V. Too	CO_{M}	WWW.	5.5	- 1	_	1.65	7	1.65	- - 11	1.65	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = -50 \mu\text{A}$	2.0	1.9	2.0	- W	1.9	TOON.	1.9	TW	V
	WWW.100X.COM.TW WWW.100X.COM.TW 100X.COM.TW	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = -50 \mu\text{A}$	3.0	2.9	3.0	- 1	2.9	. 100 X	2.9		V
		$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = -50 \mu\text{A}$	4.5	4.4	4.5	_	4.4	W.10	4.4	OM.T	V
		$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = -4.0 \text{ mA}$	3.0	2.58	NI.TV	_	2.48	WW.1	2.40	$\bar{o}_{M,j}$	V
MMI	N.100X.COW.	$V_I = V_{IH}$ or V_{IL} ; $I_O = -8.0$ mA	4.5	3.94	G_{M}	N	3.8	AM.	3.70	$e_{O_{j_0}}$	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = 50 \mu\text{A}$	2.0	001	COM	0.1	_	0.1	M:100	0.1	V
	WW.1007.CO	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = 50 \mu\text{A}$	3.0	700	oco,	0.1	-	0.1	M.1	0.1	٧
	VWW.100Y.CO	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = 50 \mu\text{A}$	4.5	W.10	0	0.1	N	0.1	MM	0.1	CO
	WWW.1007	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = 4.0 \text{ mA}$	3.0	WW.	100 X.	0.36	ĪW	0.44	NWY	0.55	V
	M.M.W.100	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = 8.0 \text{ mA}$	4.5	71111	1.7007	0.36	L-TW	0.44	N. V.	0.55	V
I _{LI}	input leakage current	$V_I = V_{CC}$ or GND	5.5	MM	74.100	0.1	\overline{M} .	1.0	- W	2.0	μА
I _{CC}	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$	5.5	-111	M.N.7	1.0	OM:	10	-	40	μА
Cı	input capacitance	100 . COW.	- ×1	-	1.5	10	CON	10	_	10	pF

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2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86

Family 74AHCT1G

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

	WWW	TEST CONDI	TIONS	WV		ON YOU	amb (°	C) (\)			
SYMBOL	PARAMETER	V.Inc. COM.	TIV as	W	25	MAN Y	-40 t	to +85	-40 t	o +125	דואט
	WW W	OTHER	V _{CC} (V)	MIN.	TYP.	MAX.	MIN.	MAX.	MIN.	MAX.	
VIH	HIGH-level input voltage	AM:100X:COD	4.5 to 5.5	2.0	NW	M.100	2.0	OM.T	2.0	-	V
VIL	LOW-level input voltage	1.M.100.5.C.	4.5 to 5.5	_	7//	0.8	OUA.	0.8	TW TW	0.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = -50 \mu\text{A}$	4.5	4.4	4.5	AW	4.4	$\mathbb{C}_{O_{I_{\alpha}}}$	4.4	-	V
	COM.TW	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = -8.0 \text{ mA}$	4.5	3.94	-	MM	3.8	N.CC	3.70	W.	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = 50 \mu\text{A}$	4.5	WT	0	0.1	0.1	0.1	O_{M}	0.1	V
	Y.COM.TW	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = 8.0 \text{ mA}$	4.5	M.TV	_ N	0.36	MM.	0.44	.con	0.55	V
luww.1	input leakage current	$V_I = V_{IH}$ or V_{IL}	5.5	\overline{OM}	W.	0.1	TWV	1.0	V-CO	2.0	μΑ
I _{CC}	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$	5.5	$\overline{co_M}$	TW	1.0	7//	10		40	μА
Δl _{CC}	additional quiescent supply current per input pin	$V_I = 3.4 \text{ V};$ other inputs at V_{CC} or GND; $I_O = 0$	5.5	(.C O)	OM.T	1.35	- 41	1.5	1.700. 1 <u>0</u> 0.7	1.5	mA
Cı	input capacitance	V.L.	-W.1	10 > _	1.5	10	_	10	4.10	10	pF

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2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86

AC CHARACTERISTICS

Type 74AHC1G86

	WWW	TEST CONDITIONS			MM.		amb (°	C) (V)			
SYMBOL	PARAMETER	WAVEFORMO	CL		25	100	-40 t	to +85	-40 to	o +125	UNIT
	WW WY	WAVEFORMS	(pF)	MIN.	TYP.	MAX.	MIN.	MAX.	MIN.	MAX.	†
V _{CC} = 3.0 to	o 3.6 V; note 1	MAY TOWN COL	TV		WY	N. W.	no Y.C	ON	TW		-
t _{PHL} /t _{PLH}	propagation delay	see Figs 5 and 6	15	1	4.0	11.0	1.0	13.0	1.0	14.0	ns
	A and B to Y	WW.100 Y C	50	N.	5.8	14.5	1.0	16.5	1.0	18.5	ns
$V_{CC} = 4.5 \text{ t}$	o 5.5 V; note 2	MW.100	OM.	-CXV		WWW	The	V.CO	M.	N	•
t _{PHL} /t _{PLH}	propagation delay	see Figs 5 and 6	15	-	3.4	6.8	1.0	8.0	1.0	8.5	ns
	A and B to Y	W 1 100 X	50	77.	4.9	8.8	1.0	10.0	1.0	11.5	ns

Notes

- Typical values are measured at V_{CC} = 3.3 V.
 Typical values are measured at V_{CC} = 4.3 V.
- 2. Typical values are measured at $V_{CC} = 5.0 \text{ V}$.

74AHCT1G86

MM	100Y.COM.TV	TEST CONDIT	T _{amb} (°C)						COM	T. I.	
SYMBOL	PARAMETER Cı		CL ¹⁰	C ₁ 25				-40 to +85		+125	UNIT
WW	W.100Y.COM	WAVEFORMS	(pF)	MIN.	TYP.	MAX.	MIN.	MAX.	MIN.	MAX.	M.I.
V _{CC} = 4.5 t	o 5.5 V; note 1	I.TW	W.	100 X .	COM	TW	•	N T	W.10	03. √1 C	OM.
t _{PHL} /t _{PLH}	t _{PLH} propagation delay	see Figs 5 and 6	15	4007	3.5	6.9	1.0	8.0	1.0	9.0	ns
	A and B to Y	WTI	50	-100	5.0	7.9	1.0	9.0	1.0	10.5	ns

Note

1. Typical values are measured at $V_{CC} = 5 \text{ V}$. WWW.100Y.COM.TW

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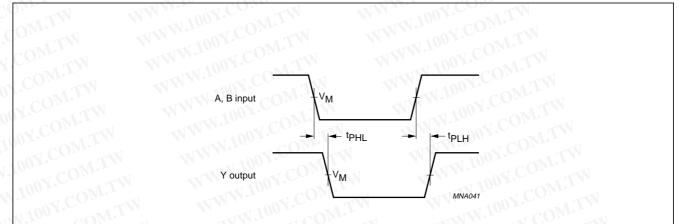
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2-input EXCLUSIVE-OR gate

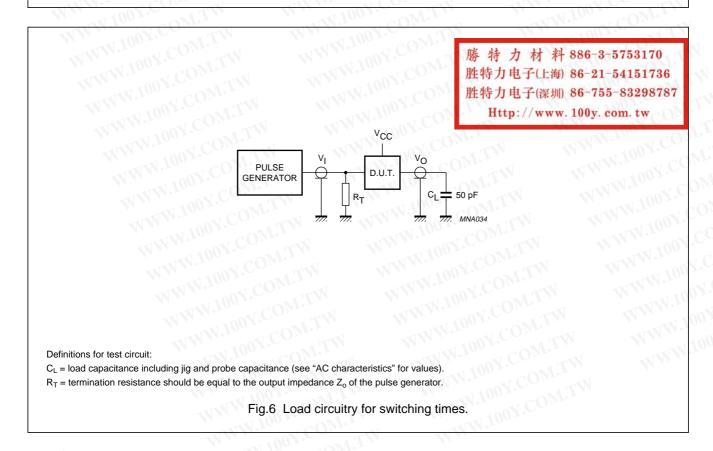
74AHC1G86; 74AHCT1G86

AC WAVEFORMS



FAMILY	V _I INPUT REQUIREMENTS	V _M INPUT	V _M OUTPUT
AHC1G	GND to V _{CC}	50% V _{CC}	50% V _{CC}
AHCT1G	GND to 3.0 V	1.5 V	50% V _{CC}

Fig.5 The input (A and B) to output (Y) propagation delays.



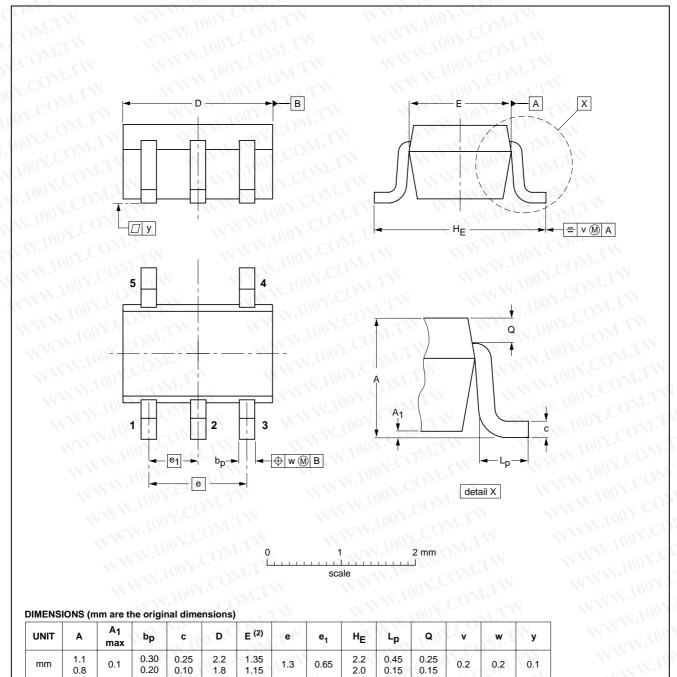
2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86

PACKAGE OUTLINES

Plastic surface mounted package; 5 leads

SOT353



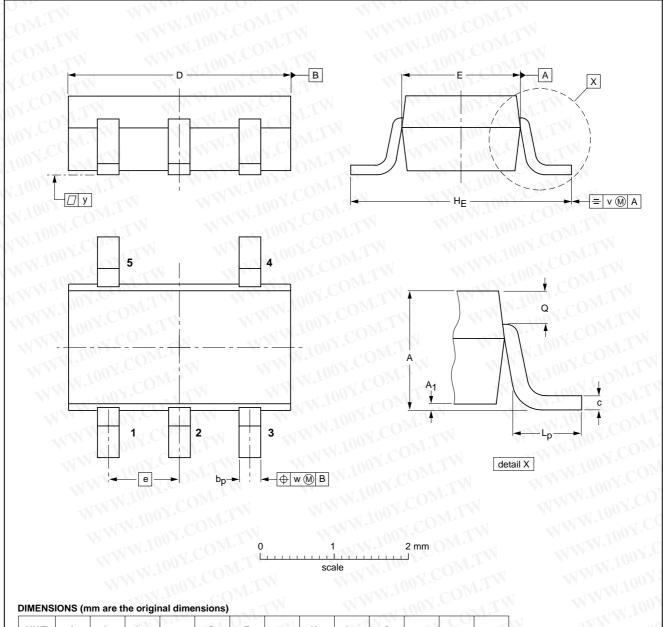
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VERSION	IEC	JEDEC	EIAJ	INW.Ing	PROJECTION	ISSUE DATE
SOT353	WV	1W.100X.	SC-88A	WW.10		97-02-28

2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86

Plastic surface mounted package; 5 leads

SOT753



UNIT	A	A ₁ 1	bp	C	O.D.C	E	e	HE	Lp	Q	100	w	y
mm	1.1 0.9	0.100 0.013		0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE		REFER	EUROPEAN	ICCUE DATE			
VERSION	IEC	JEDEC	JEITA	TANN TOO	PROJECTION	ISSUE DATE	
SOT753	WW	1W.100Y.C	SC-74A	WWW.10		02-04-16	

2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86

SOLDERING

Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferable be kept below 220 °C for thick/large packages, and below 235 °C for small/thin packages.

Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
 - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
 - smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

 For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C. A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 $^{\circ}$ C.

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Suitability of surface mount IC packages for wave and reflow soldering methods

DAGGACTI) WITH	SOLDERING METHOD			
PACKAGE ⁽¹⁾	WAVE	REFLOW ⁽²⁾		
BGA, LBGA, LFBGA, SQFP, TFBGA, VFBGA	not suitable	suitable		
HBCC, HBGA, HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, HVQFN, HVSON, SMS	not suitable ⁽³⁾	suitable		
PLCC ⁽⁴⁾ , SO, SOJ	suitable	suitable		
LQFP, QFP, TQFP	not recommended ⁽⁴⁾⁽⁵⁾	suitable		
SSOP, TSSOP, VSO	not recommended ⁽⁶⁾	suitable		

Notes

- 1. For more detailed information on the BGA packages refer to the "(LF)BGA Application Note" (AN01026); order a copy from your Philips Semiconductors sales office.
- 2. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the "Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods".
- 3. These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
- 4. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- 5. Wave soldering is suitable for LQFP, TQFP and QFP packages with a pitch (e) larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- Wave soldering is suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

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2-input EXCLUSIVE-OR gate

74AHC1G86; 74AHCT1G86

DATA SHEET STATUS

DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
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